

Addendum

HC908JB8AD/D  
Rev. 0, 4/2002

Addendum to  
MC68HC908JB8  
Technical Data



This addendum provides additional information to the  
*MC68HC908JB8 Technical Data*, Rev. 2  
(Motorola document number MC68HC908JB8/D),

**MC68HC08JB8A**

The MC68HC08JB8A is the ROM part equivalent to the MC68HC908JB8. The entire MC68HC908JB8 data book apply to this ROM device, with exceptions outlined in this addendum.

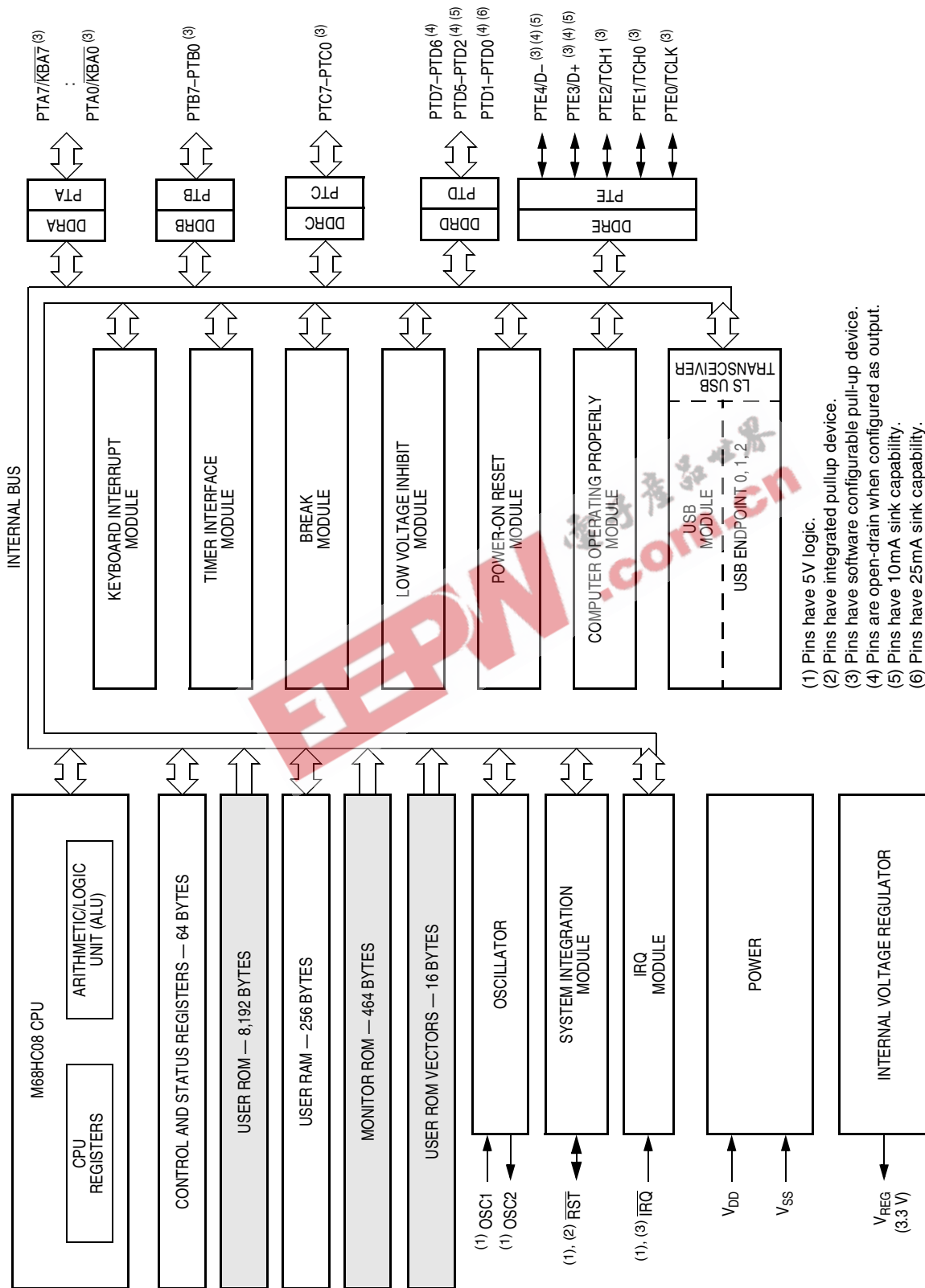
**Table 1. Summary of MC68HC08JB8A and MC68HC908JB8 Differences**

	MC68HC08JB8A	MC68HC908JB8
<b>Memory (\$DC00–\$FBFF)</b>	8,192 bytes ROM	8,192 bytes FLASH
<b>User vectors (\$FFF0–\$FFFF)</b>	16 bytes ROM	16 bytes FLASH
<b>Registers at \$FE08 and \$FF09</b>	Not used; locations are reserved.	FLASH related registers. \$FE08 — FLCR \$FF09 — FLBPR
<b>Monitor ROM (\$FC00–\$FDFF and \$FE10–\$FFDF)</b>	\$FC00–\$FDFF: Not used. \$FE10–\$FFDF: Used for testing purposes only.	Used for testing and FLASH programming/erasing.
<b>OSC1 and OSC2 pins</b>	V <sub>DD</sub> level (5V logic)	V <sub>REG</sub> level (3.3V logic)

**MCU Block Diagram** **Figure 1** shows the block diagram of the MC68HC08JB8A.

**Memory Map** The MC68HC08JB8A has 8,192 bytes of user ROM from \$DC00 to \$FBFF, and 16 bytes of user ROM vectors from \$FFF0 to \$FFFF. On the MC68HC908JB8, these memory locations are FLASH memory.

**Figure 2** shows the memory map of the MC68HC08JB8A.



- (1) Pins have 5V logic.
- (2) Pins have integrated pullup device.
- (3) Pins have software configurable pull-up device.
- (4) Pins are open-drain when configured as output.
- (5) Pins have 10mA sink capability.
- (6) Pins have 25mA sink capability.

□ Shaded blocks indicate differences to MC68HC908JB8

Figure 1. MC68HC908JB8 Block Diagram

\$0000 ↓ \$003F	I/O Registers 64 Bytes
\$0040 ↓ \$013F	RAM 256 Bytes
\$0140 ↓ \$DBFF	Unimplemented 56,000 Bytes
\$DC00 ↓ \$FBFF	ROM 8,192 Bytes
\$FC00 ↓ \$FDFF	Unimplemented 512 Bytes
\$FE00	Break Status Register (BSR)
\$FE01	Reset Status Register (RSR)
\$FE02	Reserved
\$FE03	Break Flag Control Register (BFCR)
\$FE04	Interrupt Status Register 1 (INT1)
\$FE05	Reserved
\$FE06	Reserved
\$FE07	Reserved
\$FE08	Reserved
\$FE09	Reserved
\$FE0A	Reserved
\$FE0B	Reserved
\$FE0C	Break Address High Register (BRKH)
\$FE0D	Break Address Low Register (BRKL)
\$FE0E	Break Status and Control Register (BRKSCR)
\$FE0F	Reserved
\$FE10 ↓ \$FFDF	Monitor ROM 464 Bytes
\$FFE0 ↓ \$FFEF	Reserved 16 Bytes
\$FFF0 ↓ \$FFFF	ROM Vectors 16 Bytes

**Figure 2. MC68HC08JB8A Memory Map**

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**Reserved Registers** The two registers at \$FE08 and \$FE09 are reserved locations on the MC68HC08JB8A.

On the MC68HC908JB8, these two locations are the FLASH control register and the FLASH block protect register respectively.

**Monitor ROM** The monitor program (monitor ROM: \$FE10–\$FFDF) on the MC68HC08JB8A is for device testing only. \$FC00–\$FDFF are unused.

**Electrical Specifications** Electrical specifications for the MC68HC908JB8 apply to the MC68HC08JB8A, except for the parameters indicated below.

*DC Electrical Characteristics*

**Table 2. DC Electrical Characteristics**

Characteristic <sup>(1)</sup>	Symbol	Min	Typ <sup>(2)</sup>	Max	Unit
Regulator output voltage	$V_{REG}$	3.0	3.3	3.6	V
Output high voltage ( $I_{Load} = -2.0$ mA) PTA0–PTA7, PTB0–PTB7, PTC0–PTC7, PTE0–PTE2	$V_{OH}$	$V_{REG} - 0.8$	—	—	V
Output low voltage ( $I_{Load} = 1.6$ mA) All I/O pins ( $I_{Load} = 25$ mA) PTD0–PTD1 in ILDD mode ( $I_{Load} = 10$ mA) PTE3–PTE4 with USB disabled	$V_{OL}$	— — —	— — —	0.4 0.5 0.4	V
Input high voltage All ports, OSC1 IRQ, RST	$V_{IH}$	$0.7 \times V_{REG}$ $0.7 \times V_{DD}$	— —	$V_{REG}$ $V_{DD}$	V
Input low voltage All ports, OSC1 IRQ, RST	$V_{IL}$	$V_{SS}$ $V_{SS}$	— —	$0.3 \times V_{REG}$ $0.3 \times V_{DD}$	V
Output low current ( $V_{OL} = 2.0$ V) PTD2–PTD5 in LDD mode	$I_{OL}$	12 (17)	17 (22)	22 (27)	mA
$V_{DD}$ supply current, $V_{DD} = 5.25$ V, $f_{OP} = 3$ MHz					
Run, with low speed USB <sup>(3)</sup>	$I_{DD}$	—	6.0 (5.0)	7.5	mA
Run, with USB suspended <sup>(3)</sup>		—	5.5 (4.5)	6.5	mA
Wait, with low speed USB <sup>(4)</sup>		—	4.0 (3.0)	5.0	mA
Wait, with USB suspended <sup>(4)</sup>		—	3.0 (2.5)	4.0	mA
Stop <sup>(5)</sup> 0 °C to 70 °C		—	30	100	μA

Table 2. DC Electrical Characteristics

Characteristic <sup>(1)</sup>	Symbol	Min	Typ <sup>(2)</sup>	Max	Unit
I/O ports Hi-Z leakage current	$I_{IL}$	—	—	$\pm 10$	$\mu A$
Input current	$I_{IN}$	—	—	$\pm 1$	$\mu A$
Capacitance Ports (as input or output)	$C_{Out}$ $C_{In}$	— —	— —	12 8	pF
POR re-arm voltage <sup>(6)</sup>	$V_{POR}$	0	—	100	mV
POR rise-time ramp rate <sup>(7)</sup>	$R_{POR}$	0.035	—	—	V/ms
Monitor mode entry voltage	$V_{DD}+V_{HI}$	$1.4 \times V_{DD}$	—	$2 \times V_{DD}$	V
Pullup resistors Port A, port B, port C, PTE0–PTE2, $\overline{RST}$ , $\overline{IRQ}$ PTE3–PTE4 (with USB module disabled) D– (with USB module enabled)	$R_{PU}$	25 4 1.2	40 5 1.5	55 6 2.0	k $\Omega$
LVI reset	$V_{LVR}$	2.8 (2.4)	3.3 (2.7)	3.8 (3.0) <sup>(8)</sup>	V

- $V_{DD} = 4.0$  to  $5.5$  Vdc,  $V_{SS} = 0$  Vdc,  $T_A = T_L$  to  $T_H$ , unless otherwise noted.
- Typical values reflect average measurements at midpoint of voltage range,  $25^\circ C$  only.
- Run (operating)  $I_{DD}$  measured using external square wave clock source ( $f_{XCLK} = 6$  MHz). All inputs  $0.2$  V from rail. No dc loads. Less than  $100$  pF on all outputs.  $C_L = 20$  pF on OSC2. All ports configured as inputs. OSC2 capacitance linearly affects run  $I_{DD}$ . Measured with all modules enabled.
- Wait  $I_{DD}$  measured using external square wave clock source ( $f_{XCLK} = 6$  MHz); all inputs  $0.2$  V from rail; no dc loads; less than  $100$  pF on all outputs.  $C_L = 20$  pF on OSC2;  $15$  k $\Omega \pm 5\%$  termination resistors on D+ and D– pins; all ports configured as inputs; OSC2 capacitance linearly affects wait  $I_{DD}$ .
- STOP  $I_{DD}$  measured with USB in suspend mode; OSC1 grounded; transceiver pullup resistor of  $1.5$  k $\Omega \pm 5\%$  between  $V_{REG}$  and D– pins and  $15$  k $\Omega \pm 5\%$  termination resistor on D+ pin; no port pins sourcing current.
- Maximum is highest voltage that POR is guaranteed.
- If minimum  $V_{REG}$  is not reached before the internal POR reset is released,  $\overline{RST}$  must be driven low externally until minimum  $V_{REG}$  is reached.
- The numbers in parenthesis are MC68HC08JB8 (non-A part) values.

Memory  
Characteristics

Table 3. Memory Characteristics

Characteristic	Symbol	Min	Max	Unit
RAM data retention voltage	$V_{RDR}$	1.3	—	V

Notes:

Since MC68HC08JB8A is a ROM device, FLASH memory electrical characteristics do not apply.

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## MC68HC08JB8A Order Numbers

These part numbers are generic numbers only. To place an order, ROM code must be submitted to the ROM Processing Center (RPC).

Table 4. MC68HC08JB8A Order Numbers

MC order number	Package	Operating temperature range
MC68HC08JB8AJP	20-pin PDIP	0 °C to +70 °C
MC68HC08JB8AJDW	20-pin SOIC	0 °C to +70 °C
MC68HC08JB8AADW	28-pin SOIC	0 °C to +70 °C
MC68HC08JB8AFB	44-pin QFP	0 °C to +70 °C

## MC68HC08JB8A and MC68HC08JB8 Differences

The MC68HC08JB8A and MC68HC08JB8 are identical devices, except for the following:

Table 5. MC68HC08JB8A and MC68HC08JB8 Differences

	MC68HC08JB8A	MC68HC08JB8
OSC1 and OSC2 pins	V <sub>DD</sub> level (5V logic)	V <sub>REG</sub> level (3.3V logic)
Output low current on PTD2–PTD5 in LDD mode	See <a href="#">Table 2 . DC Electrical Characteristics</a> . The numbers in parenthesis are MC68HC08JB8 values.	
Operating I <sub>DD</sub> currents		
LVI trip points		

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**NOTES**

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Silicon Harbour Centre, 2 Dai King Street  
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